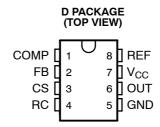
SGLS135F - SEPTEMBER 2002 - REVISED OCTOBER 2010

- Controlled Baseline
 - One Assembly
 - One Test Site
 - One Fabrication Site
- Extended Temperature Performance of -55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product Change Notification
- Qualification Pedigree[†]
- ESD Protection Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- 100 μA Typical Starting Supply Current
- 500 μA Typical Operating Supply Current
- [†] Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- Operation to 1 MHz
- Internal Soft Start
- Internal Fault Soft Start
- Internal Leading-Edge Blanking of the Current Sense Signal
- 1 Amp Totem-Pole Output
- 70 ns Typical Response from Current-Sense to Gate Drive Output
- 1.5% Tolerance Voltage Reference
- Same Pinout as UC3842 and UC3842A



description

The UCC2800/1/2/3/4/5 family of high-speed, low-power integrated circuits contain all of the control and drive components required for off-line and dc-to-dc fixed frequency current-mode switching power supplies with minimal parts count.

These devices have the same pin configuration as the UC2842/3/4/5 family and also offer the added features of internal full-cycle soft start and internal leading-edge blanking of the current-sense input.

The UCC2800/1/2/3/4/5 family offers choice of maximum duty cycle and critical voltage levels. Lower reference parts such as the UCC2803 and UCC2805 fit best into battery operated systems, while the higher reference and the higher UVLO hysteresis of the UCC2802 and UCC2804 make these ideal choices for use in off-line power supplies.

PART NUMBER	MAXIMUM DUTY CYCLE	REFERENCE VOLTAGE	TURN-ON THRESHOLD	TURN-OFF THRESHOLD
UCC2800	100%	5 V	7.2 V	6.9 V
UCC2801	50%	5 V	9.4 V	7.4 V
UCC2802	100%	5 V	12.5 V	8.3 V
UCC2803	100%	4 V	4.1 V	3.6 V
UCC2804	50%	5 V	12.5 V	8.3 V
UCC2805	50%	4 V	4.1 V	3.6 V



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

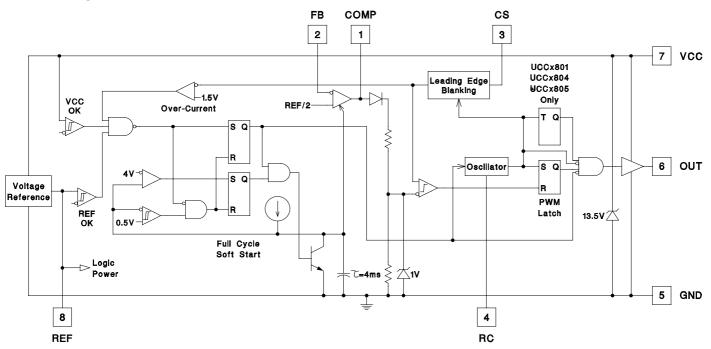


ORDERING INFORMATION[†]

T _A	PACK	AGE [‡]	ORDERABLE PART NUMBER	TOP-SIDE MARKING
			UCC2800QDREP	2800EP
			UCC2801QDREP	2801EP
-40°C to 125°C	000 0		UCC2802QDREP	2802EP
-40°C to 125°C	SOP – D	Tape and reel	UCC2803QDREP	2803EP
			UCC2804QDREP	2804EP
			UCC2805QDREP	2805EP
			UCC2800MDREP	2800EP
–55°C to 125°C	SOP – D	Tape and reel	UCC2801MDREP	2801EP
			UCC2803MDREP	2803EP

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

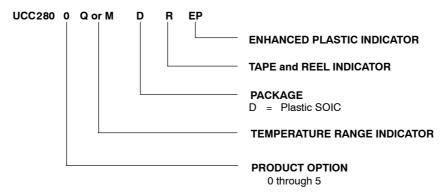
block diagram



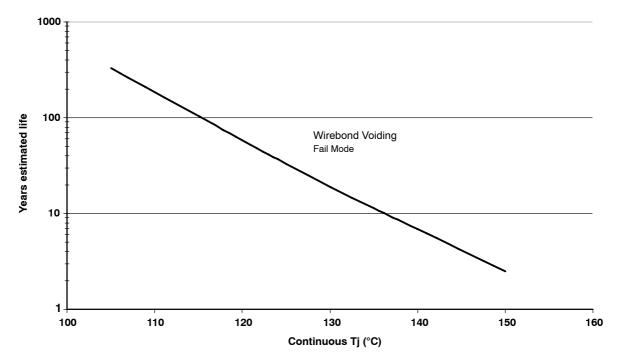


[‡] Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

Ordering Information



UCC280XXD-EP Operating Life Derating Chart



NOTES: A. See datasheet for Absolute Maximum and Minimum Recommended Operating Conditions

- B. Silicon operating life design Goal is 10 @ 105°C junction temperature (does not include package interconnect life).
- C. Enhanced plastic product disclaimer applies.

UCC2800/2801/2802/2803/2804/2805-EP LOW-POWER BICMOS CURRENT-MODE PWM

SGLS135F - SEPTEMBER 2002 - REVISED OCTOBER 2010

electrical characteristics, T_A = -40°C to 125°C for Q temp and T_A = -55°C to 125°C for M temp, V_{CC} = 10 V (see Note 1), R_T = 100 k Ω from REF to RC, C_T = 330 pF from RC to GND, 0.1 F capacitor from V_{CC} to GND, 0.1 F capacitor from V_{REF} to GND and T_A = T_J (unless otherwise stated)

PARAMETER	TEST C		UCC280XQ, UCC280XM			
			MIN	TYP	MAX	
Reference Section						
O to to allow	T 0500 L 0.0 A	UCC2800/01/02/04	4.925	5	5.075	.,
Output voltage	$T_J = 25^{\circ} C$, $I = 0.2 \text{ mA}$	UCC2803/05	3.94	4	4.06	V
Load regulation voltage	I = 0.2 mA to 5 mA		10	30	mV	
		T _J = 25°C			1.9	
Line regulation voltage	V _{CC} = 10 V to clamp	$T_J = -40$ °C to 125°C and $T_J = -55$ °C to 125°C			2.5	mV/V
T. 1	0 11 5	UCC2800/01/02/04	4.88	5	5.1	
Total variation voltage	See Note 5	UCC2803/05	3.9	4	4.08	V
Output noise voltage	f = 10 Hz to 10 kHz, See Note 7	T _J = 25°C		130		μV
Long term stability	1000 hours, See Note 7	T _A = 125°C		5		mV
Output short-circuit current		•	-5		-35	mA



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[‡] Unless otherwise indicated, voltages are reference to ground and currents are positive into and negative out of the specified terminals.

[§] In normal operation, V_{CC} is powered through a current limiting resistor. Absolute maximum of 12 V applies when V_{CC} is driven from a low impedance source such that I_{CC} does not exceed 30 mA (which includes gate drive current requirement).

UCC2800/2801/2802/2803/2804/2805-EP LOW-POWER BICMOS CURRENT-MODE PWM

SGLS135F - SEPTEMBER 2002 - REVISED OCTOBER 2010

electrical characteristics, T_A = -40°C to 125°C for Q temp and T_A = -55°C to 125°C for M temp, V_{CC} = 10 V (see Note 1), R_T = 100 k Ω from REF to RC, C_T = 330 pF from RC to GND, 0.1 F capacitor from V_{CC} to GND, 0.1 F capacitor from V_{REF} to GND and T_A = T_J (unless otherwise stated)

Desimator Section	PARAMETER	TEST COND	TEST CONDITIONS				
Descillator frequency See Note 2 UCC2803/05 28 31 38 38 38 38 38 38 3		1.201 5511.2		MIN	TYP	MAX	
See Note 2 UCC2803/05 26 31 38 Refresher	Oscillator Section						
CC2803/05 26 31 36 36 36 36 36 36 3	Oscillator fraguesco	Con Note 0	UCC2800/01/02/04	40	46	52	kHz
Amplitude peak-to-peak	Oscillator frequency	See Note 2	UCC2803/05	26	31	36	KHZ
Second Parish	Temperature stability	See Note 7			2.5%		
Proof Amplifier Section COMP = 2.5 V UCC2800/01/02/04 2.44 2.5 2.56 COMP = 2 V UCC2803/05 1.95 2 2.05 COMP = 2 V UCC2803/05 2.05 2.05 COMP = 2 V UCC2803/05 2.05 2.05 COMP = 2 V UCC2803/05 2.	Amplitude peak-to-peak			2.25	2.4	2.55	V
Input voltage	Oscillator peak voltage				2.45		V
Input voltage COMP = 2 V	Error Amplifier Section	·					
COMP = 2 V UCC2803/05 1.95 2 2.05 1.95 1.95 1.95 2 2.05 1.95		COMP = 2.5 V	UCC2800/01/02/04	2.44	2.5	2.56	.,
Open loop voltage gain FB = 2.7 V, COMP = 1.1 V 0.3 3.5 M COMP sink current FB = 2.7 V, COMP = 1.1 V 0.3 3.5 m COMP source current FB = 1.8 V, COMP = REF - 1.2 V -0.2 -0.5 -0.8 m Gain bandwidth product See Note 7 2 M M PWM Section Maximum duty cycle COMP = 0 V 48% 49% 50% Minimum duty cycle COMP = 0 V 48% 49% 50% Current Sense Section Gain See Note 3 1.1 1.65 1.8 V, Maximum input signal COMP = 5 V, See Note 4 0.9 1 1.1 1.6 1.1 1.6 1.1	Input voltage	COMP = 2 V	UCC2803/05	1.95	2	2.05	V
COMP sink current FB = 2.7 V, COMP = 1.1 V 0.3 3.5 m COMP source current FB = 1.8 V, COMP = REF − 1.2 V −0.2 −0.5 −0.8 m Gain bandwidth product See Note 7 2 M M PWM Section Maximum duty cycle COMP = 0 V 0 0 Current Sense Section Gain See Note 3 1.1 1.65 1.8 V/ Maximum input signal COMP = 5 V, See Note 4 0.9 1 1.1 V Input bias current COMP = 5 V, See Note 4 0.9 1 1.1 V CS blank time CS = 0 V 50 100 150 n COMP to CS offset voltage CS = 0 V 0.45 0.9 1.35 N Output Section (OUT) Low-level output voltage All parts 0.1 0.4 IouT = 20 mA All parts 0.1 0.4 IouT = 20 mA, V _C	Input bias current			-1		1	μΑ
COMP source current FB = 1.8 V, COMP = REF − 1.2 V −0.2 −0.5 −0.8 m Gain bandwidth product See Note 7 2 M PWM Section Maximum duty cycle COMP = 0 V 0 Maximum duty cycle COMP = 0 V 0 Current Sense Section Gain See Note 3 1.1 1.65 1.8 V/ Maximum input signal COMP = 5 V, See Note 4 0.9 1 1.1 1.65 1.8 V/ Input bias current -200 200 n CS blank time -200 200 n CS blank time -200 200 n COMP to CS offset voltage CS = 0 V 0.45 0.9 1.35 0.0 Output Section (OUT) -200 mA All parts 0.15 0.4 1.0uT = 20 mA Al	Open loop voltage gain			60	80		db
PWM Section UCC2800/02/03 97% 99% 100% UCC2801/04/05 48% 49% 50% Maximum duty cycle COMP = 0 V COMP = 0 V 0 CUCRENT Sense Section See Note 3 1.1 1.65 1.8 V/1.05 1.0 M/2.05 1.0 M/2.0	COMP sink current	FB = 2.7 V, COMP = 1.1 V		0.3		3.5	mA
PWM Section Maximum duty cycle UCC2800/02/03 97% 99% 100% Minimum duty cycle COMP = 0 V 0 0 Current Sense Section Gain See Note 3 1.1 1.65 1.8 V/ Maximum input signal COMP = 5 V, See Note 4 0.9 1 1.1 N Input bias current -200 1 1.1 N CS blank time 50 100 150 n Overcurrent threshold voltage CS = 0 V 0.45 0.9 1.35 N COMP to CS offset voltage CS = 0 V 0.45 0.9 1.35 N Output Section (OUT) Low-level output voltage Input = 20 mA All parts 0.1 0.4 Input = 20 mA All parts 0.15 0.4 Input = 20 mA, V _{CC} = 5 V UCC2803/05 0.15 0.4 Input = -20 mA All parts 0.15 0.4 Input = -20 mA, V _{CC} = 5 V UCC2803/05 <t< td=""><td>COMP source current</td><td>FB = 1.8 V, COMP = REF -</td><td>- 1.2 V</td><td>-0.2</td><td>-0.5</td><td>-0.8</td><td>mA</td></t<>	COMP source current	FB = 1.8 V, COMP = REF -	- 1.2 V	-0.2	-0.5	-0.8	mA
Maximum duty cycle UCC2800/02/03 97% 99% 100% Minimum duty cycle COMP = 0 V 0 Current Sense Section Gain See Note 3 1.1 1.65 1.8 V/ Maximum input signal COMP = 5 V, See Note 4 0.9 1 1.1 V Input bias current -200 200 n CS blank time 50 100 150 n Overcurrent threshold voltage CS = 0 V 0.45 0.9 1.35 V Output Section (OUT) Iour = 20 mA All parts 0.1 0.4 Iour = 20 mA All parts 0.1 0.4 Iour = 20 mA All parts 0.7 1.2 High-level output voltage V _{SAT} (V _{CC} – OUT) Iour = -20 mA All parts 0.15 0.4 Iour = -20 mA	Gain bandwidth product	See Note 7			2		MHz
Maximum duty cycle COMP = 0 V 48% 49% 50% Current Sense Section Gain See Note 3 1.1 1.65 1.8 V/ Maximum input signal COMP = 5 V, See Note 4 0.9 1 1.1 V Input bias current -200 200 n CS blank time 50 100 150 n Overcurrent threshold voltage 1.42 1.55 1.68 V COMP to CS offset voltage CS = 0 V 0.45 0.9 1.35 V Output Section (OUT) Low-level output voltage IouT = 20 mA All parts 0.1 0.4 IouT = 20 mA All parts 0.15 0.4 IouT = 20 mA, V _{CC} = 5 V UCC2803/05 0.15 0.4 IouT = -20 mA All parts 0.15 <td>PWM Section</td> <td>1</td> <td></td> <td></td> <td></td> <td></td> <td></td>	PWM Section	1					
Minimum duty cycle			UCC2800/02/03	97%	99%	100%	
Current Sense Section Gain See Note 3 1.1 1.65 1.8 V/ Maximum input signal COMP = 5 V, See Note 4 0.9 1 1.1 V/ Input bias current -200 200 n CS blank time 50 100 150 n Overcurrent threshold voltage 1.42 1.55 1.68 V/ COMP to CS offset voltage CS = 0 V 0.45 0.9 1.35 V/ Output Section (OUT) IouT = 20 mA All parts 0.1 0.4 IouT = 20 mA All parts 0.35 0.9 IouT = 20 mA, V _{CC} = 5 V UCC2803/05 0.15 0.4 IouT = 20 mA, V _{CC} = 0 V All parts 0.7 1.2 IouT = -20 mA All parts 0.15 0.4 IouT = -20 mA All parts 0.15 0.4 IouT = -20 mA All parts 0.15 0.4 IouT = -20 mA, V _{CC} =	Maximum duty cycle		UCC2801/04/05	48%	49%	50%	
Current Sense Section Gain See Note 3 1.1 1.65 1.8 V/ Maximum input signal COMP = 5 V, See Note 4 0.9 1 1.1 V/ Input bias current -200 200 n CS blank time 50 100 150 n Overcurrent threshold voltage 1.42 1.55 1.68 V/ COMP to CS offset voltage CS = 0 V 0.45 0.9 1.35 V/ Output Section (OUT) IouT = 20 mA All parts 0.1 0.4 IouT = 20 mA All parts 0.35 0.9 IouT = 20 mA, V _{CC} = 5 V UCC2803/05 0.15 0.4 IouT = -20 mA All parts 0.7 1.2 IouT = -20 mA All parts 0.15 0.4 IouT = -20 mA All parts 0.15 0.4 IouT = -20 mA All parts 0.15 0.4 IouT = -20 mA All	Minimum duty cycle	COMP = 0 V	1			0	
Maximum input signal COMP = 5 V, See Note 4 0.9							
Input bias current	Gain	See Note 3		1.1	1.65	1.8	V/V
Input bias current	Maximum input signal	COMP = 5 V, See Note 4		0.9	1	1.1	V
Overcurrent threshold voltage 1.42 1.55 1.68 N COMP to CS offset voltage CS = 0 V 0.45 0.9 1.35 N Output Section (OUT) IouT = 20 mA All parts 0.1 0.4 IouT = 200 mA All parts 0.35 0.9 IouT = 50 mA, V _{CC} = 5 V UCC2803/05 0.15 0.4 IouT = -20 mA All parts 0.15 0.4 IouT = -20 mA All parts 1 1.9 IouT = -20 mA All parts 1 1.9 IouT = -50 mA, V _{CC} = 5 V UCC2803/05 0.4 0.9 Rise time C _L = 1 nF 41 70 n	Input bias current			-200		200	nA
COMP to CS offset voltage	CS blank time			50	100	150	ns
COMP to CS offset voltage CS = 0 V 0.45 0.9 1.35 V Output Section (OUT) I _{OUT} = 20 mA All parts 0.1 0.4 I _{OUT} = 20 mA All parts 0.35 0.9 I _{OUT} = 50 mA, V _{CC} = 5 V UCC2803/05 0.15 0.4 I _{OUT} = 20 mA, V _{CC} = 0 V All parts 0.7 1.2 I _{OUT} = -20 mA All parts 0.15 0.4 I _{OUT} = -20 mA All parts 1 1.9 I _{OUT} = -50 mA, V _{CC} = 5 V UCC2803/05 0.4 0.9 Rise time C _L = 1 nF 41 70 n	Overcurrent threshold voltage			1.42	1.55	1.68	V
Output Section (OUT) Low-level output voltage IOUT = 20 mA		CS = 0 V		0.45	0.9	1.35	V
	• • • • • • • • • • • • • • • • • • • •	I _{OLIT} = 20 mA	All parts		0.1	0.4	
			-		0.35	0.9	
	Low-level output voltage		· ·				V
							•
			-				
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	High-level output voltage Vont (Voc - OUT)						V
Rise time C _L = 1 nF 41 70 n	SAL (*CC 331)		-				-
	Rise time		<u>'</u>				ns
	Fall time	C _L = 1 nF			44	75	ns



UCC2800/2801/2802/2803/2804/2805-EP LOW-POWER BICMOS CURRENT-MODE PWM

SGLS135F - SEPTEMBER 2002 - REVISED OCTOBER 2010

electrical characteristics, T_A = -40°C to 125°C for Q temp and T_A = -55°C to 125°C for M temp, V_{CC} = 10 V (see Note 1), R_T = 100 k Ω from REF to RC, C_T = 330 pF from RC to GND, 0.1 F capacitor from V_{CC} to GND, 0.1 F capacitor from V_{REF} to GND and T_A = T_J (unless otherwise stated)

PARAMETER	TEST CONDITI	TEST CONDITIONS				UNIT
		MIN	TYP	MAX		
Undervoltage Lockout Section						
		UCC2800	6.6	7.2	7.8	
Chart the cools and	Con Note C	UCC2801	8.6	9.4	10.2	V
Start threshold	See Note 6	UCC2802/04	11.5	12.5	13.5	V
		UCC2803/05	3.7	4.1	4.5	
		UCC2800	6.3	6.9	7.5	
0	See Note 6	UCC2801	6.8	7.4	8	v
Stop threshold	See Note 6	UCC2802/04	7.6	8.3	9	
		UCC2803/05	3.2	3.6	4	
		UCC2800	0.12	0.3	0.48	
0		UCC2801	1.6	2	2.4	
Start to stop hysteresis		UCC2802/04	3.5	4.2	5.1	V
		UCC2803/05	0.2	0.5	0.8	
Soft Start Section						
COMP rise time	FB = 1.8 V, Rise from 0.5 V	to REF – 1 V		4	10	ms
Overall Section						
Start-up current	V _{CC} < Start threshold			0.1	0.2	mA
Operating supply current	FB = 0 V, CS = 0 V			0.5	1	mA
V _{CC} internal zener voltage	I _{CC} = 10 mA, See Note 6 ar	12	13.5	15	٧	
V _{CC} internal zener voltage minus start threshold voltage	See Note 6	UCC2802/04	0.5	1		٧

- NOTES: 1. Adjust V_{CC} above the start threshold before setting at 10 V.
 - 2. Oscillator frequency for the UCC2800, UCC2802, and UCC2803 is the output frequency. Oscillator frequency for the UCC2801, UCC2804, and UCC2805 is twice the output frequency.

$$A = \frac{\Delta V_{COMP}}{\Delta V_{COMP}}$$

3. Gain is defined by:

 $0\,\leq\,V_{CS}\,\leq\,0.8\,V$

- 4. Parameter measured at trip point of latch with Pin 2 at 0 V
- 5. Total variation includes temperature stability and load regulation.
- 6. Start threshold, stop threshold, and zener shunt thresholds track one another.
- 7. Not production tested
- 8. The device is fully operating in clamp mode as the forcing current is higher than the normal operating supply current.



UCC2800/2801/2802/2803/2804/2805-EP LOW-POWER BICMOS CURRENT-MODE PWM

SGLS135F - SEPTEMBER 2002 - REVISED OCTOBER 2010

detailed terminal descriptions

COMP

COMP is the output of the error amplifier and the input of the PWM comparator.

Unlike other devices, the error amplifier in the UCC2800 family is a true, low output-impedance, 2 MHz operational amplifier. As such, the COMP terminal can both source and sink current. However, the error amplifier is internally current limited, so that one can command zero duty cycle by externally forcing COMP to GND.

The UCC2800 family features built-in full cycle soft start. Soft start is implemented as a clamp on the maximum COMP voltage.

CS

CS is the input to the current sense comparators. The UCC2800 family has two different current sense comparators - the PWM comparator and an overcurrent comparator.

The UCC2800 family contains digital current sense filtering, which disconnects the CS terminal from the current sense comparator during the 100 ns interval immediately following the rising edge of the OUT pin. This digital filtering, also called leading-edge blanking, means that in most applications, no analog filtering (RC filter) is required on CS. Compared to an external RC filter technique, the leading-edge blanking provides a smaller effective CS to OUT propagation delay. Note, however, that the minimum non-zero on-time of the OUT signal is directly affected by the leading-edge-blanking and the CS to OUT propagation delay.

The overcurrent comparator is only intended for fault sensing, and exceeding the over-current threshold will cause a soft start cycle.

FB

FB is the inverting input of the error amplifier. For best stability, keep FB lead length as short as possible and FB stray capacitance as small as possible.

ground (GND)

GND is reference ground and power ground for all functions on this part.

OUT

OUT is the output of a high-current power driver capable of driving the gate of a power MOSFET with peak currents exceeding 750 mA. OUT is actively held low when V_{CC} is below the UVLO threshold.

The high-current power driver consists of FET output devices, which can switch all of the way to GND and all of the way to V_{CC} . The output stage also provides a low impedance to overshoot and undershoot. This means that in many cases, external schottky clamp diodes are not required.



UCC2800/2801/2802/2803/2804/2805-EP LOW-POWER BICMOS CURRENT-MODE PWM

SGLS135F - SEPTEMBER 2002 - REVISED OCTOBER 2010

detailed descriptions (continued)

RC

RC is the oscillator timing pin. For fixed frequency operation, set timing capacitor charging current by connecting a resistor from REF to RC. Set frequency by connecting timing capacitor from RC to GND. For the best perforance, keep the timing capacitor lead to GND as short and direct as possible. If possible, use separate ground traces for the timing capacitor and all other functions.

The frequency of oscillation can be estimated with the following equations:

UCC2800/01/02/04 :
$$F = \frac{1.5}{R \times C}$$

UCC2803/UCC2805 :
$$F = \frac{1.0}{R \times C}$$

(1)

where frequency is in Hz, resistance is in ohms, and capacitance is in farads. The recommended range of timing resistors is between 10k and 200k and timing capacitor is 100 pF to 1000 pF. Never use a timing resistor less than 10k

To prevent noise problems, bypass V_{CC} to GND with a ceramic capacitor as close to the V_{CC} pin as possible. An electrolytic capacitor may also be used in addition to the ceramic capacitor.

voltage reference (REF)

REF is the voltage reference for the error amplifier and also for many other functions on the IC. REF is also used as the logic power supply for high speed switching logic on the IC.

When V_{CC} is greater than 1 V and less than the UVLO threshold, REF is pulled to ground through a 5 k Ω resistor. This means that REF can be used as a logic output indicating power system status. It is important for reference stability that REF is bypassed to GND with a ceramic capacitor as close to the pin as possible. An electrolytic capacitor may also be used in addition to the ceramic capacitor. A minimum of 0.1 μ F ceramic is required. Additional REF bypassing is required for external loads greater than 2.5 mA on the reference.

To prevent noise problems with high speed switching transients, bypass REF to ground with a ceramic capacitor close to the IC package.

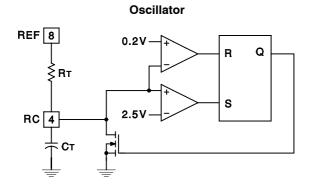
power (V_{CC})

 V_{CC} is the power input connection for this device. In normal operation, V_{CC} is powered through a current limiting resistor. Although quiescent V_{CC} current is very low, total supply current will be higher, depending on the OUT current. Total V_{CC} current is the sum of quiescent V_{CC} current and the average OUT current. Knowing the operating frequency and the MOSFET gate charge (Q_q) , average OUT current can be calculated from:

$$I_{OUT} = Q_g \times F$$

(2)

PARAMETER MEASUREMENT INFORMATION



The UCC3800/1/2/3/4/5 oscillator generates a sawtooth waveform on RC. The rise time is set by the time constant of R_T and C_T . The fall time is set by C_T and an internal transistor on-resistance of approximately 125. During the fall time, the output is off and the maximum duty cycle is reduced below 50% or 100% depending on the part number. Larger timing capacitors increase the discharge time and reduce the maximum duty cycle and frequency.

Figure 1

UCC1803/05 V_{REF} vs V_{CC} ; I_{LOAD} = 0.5 mA

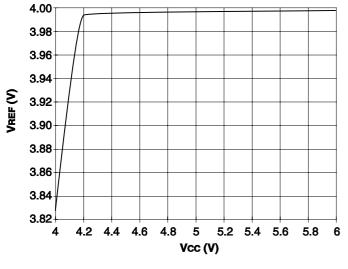
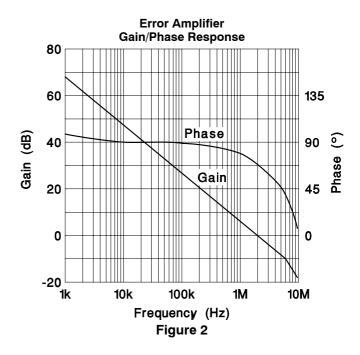


Figure 3



UCC1800/01/02/04 Oscillator Frequency vs R_T and C_T

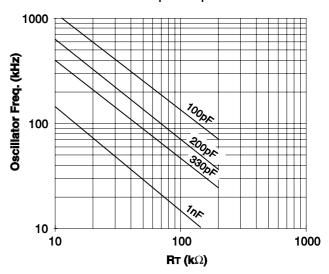
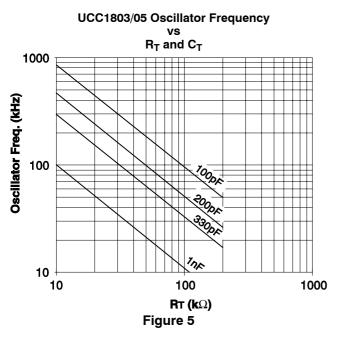
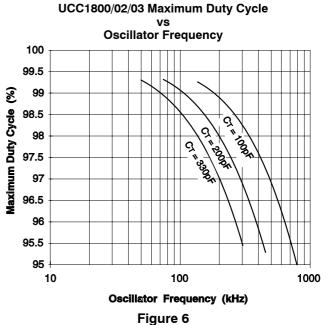


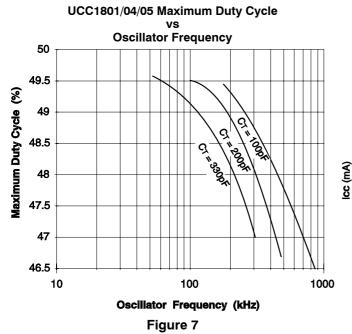
Figure 4

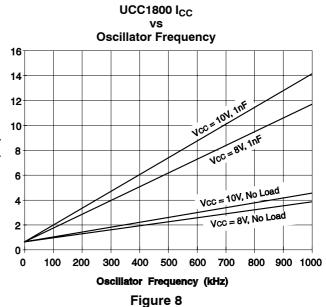


PARAMETER MEASUREMENT INFORMATION

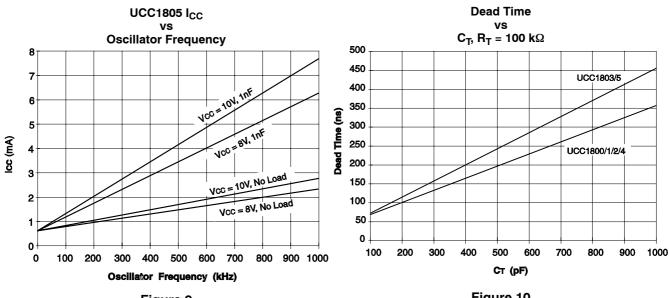








PARAMETER MEASUREMENT INFORMATION





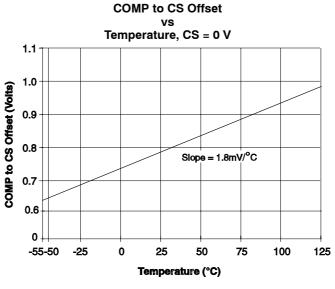


Figure 11

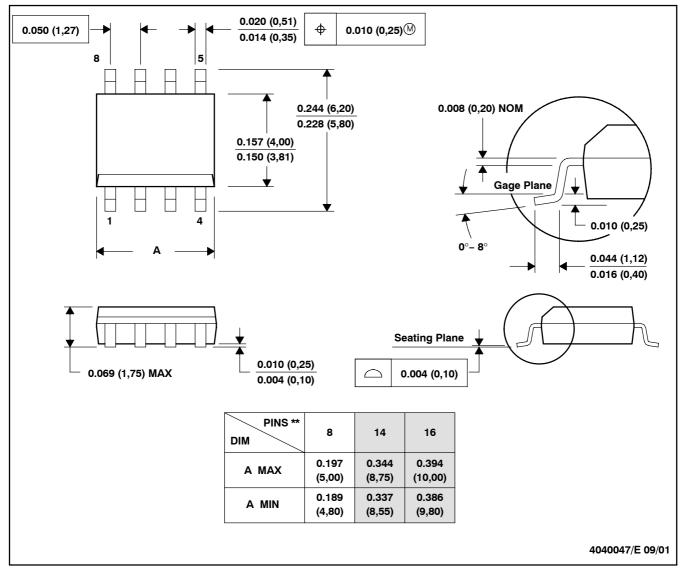
SGLS135F - SEPTEMBER 2002 - REVISED OCTOBER 2010

MECHANICAL DATA

D (R-PDSO-G**)

8 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

17-Aug-2010

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
UCC2800MDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
UCC2800QDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
UCC2801MDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
UCC2801MDREPG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
UCC2801QDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
UCC2802QDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distribute or Sales Office
UCC2803MDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distribute or Sales Office
UCC2803QDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
UCC2804QDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distribute or Sales Office
UCC2805QDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
V62/03624-01XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
V62/03624-02XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
V62/03624-03XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
V62/03624-04XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distribute or Sales Office
V62/03624-05XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distribute or Sales Office
V62/03624-06XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distribute or Sales Office
V62/03624-07XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distribute or Sales Office





www.ti.com 17-Aug-2010

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
V62/03624-08XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
V62/03624-09XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF UCC2800-EP, UCC2801-EP, UCC2802-EP, UCC2803-EP, UCC2804-EP, UCC2805-EP:

- Catalog: UCC2800, UCC2801, UCC2802, UCC2803, UCC2804, UCC2805
- Automotive: UCC2800-Q1, UCC2801-Q1, UCC2802-Q1, UCC2803-Q1, UCC2804-Q1, UCC2805-Q1
- Military: UCC2802M, UCC2803M



PACKAGE OPTION ADDENDUM



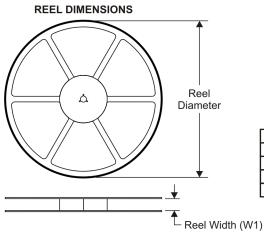
www.ti.com 17-Aug-2010

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Military QML certified for Military and Defense Applications

www.ti.com 16-Aug-2010

TAPE AND REEL INFORMATION



TAPE DIMENSIONS KO P1 BO W Cavity A0

	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

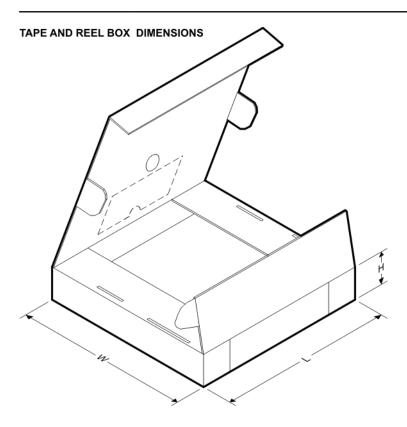


*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UCC2800MDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	4.0	12.0	Q1
UCC2800QDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	4.0	12.0	Q1
UCC2801MDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	4.0	12.0	Q1
UCC2801QDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	4.0	12.0	Q1
UCC2802QDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	4.0	12.0	Q1
UCC2803MDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	4.0	12.0	Q1
UCC2803QDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	4.0	12.0	Q1
UCC2804QDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	4.0	12.0	Q1
UCC2805QDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	4.0	12.0	Q1



www.ti.com 16-Aug-2010



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UCC2800MDREP	SOIC	D	8	2500	367.0	367.0	35.0
UCC2800QDREP	SOIC	D	8	2500	367.0	367.0	35.0
UCC2801MDREP	SOIC	D	8	2500	367.0	367.0	35.0
UCC2801QDREP	SOIC	D	8	2500	367.0	367.0	35.0
UCC2802QDREP	SOIC	D	8	2500	367.0	367.0	35.0
UCC2803MDREP	SOIC	D	8	2500	367.0	367.0	35.0
UCC2803QDREP	SOIC	D	8	2500	367.0	367.0	35.0
UCC2804QDREP	SOIC	D	8	2500	367.0	367.0	35.0
UCC2805QDREP	SOIC	D	8	2500	367.0	367.0	35.0

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products Applications Amplifiers amplifier.ti.com Audio www.ti.com/audio **Data Converters** dataconverter.ti.com Automotive www.ti.com/automotive **DLP® Products** www.dlp.com Communications and www.ti.com/communications Telecom DSP Computers and www.ti.com/computers dsp.ti.com Peripherals Clocks and Timers www.ti.com/clocks Consumer Electronics www.ti.com/consumer-apps Interface interface.ti.com **Energy** www.ti.com/energy Industrial www.ti.com/industrial Logic logic.ti.com Power Mgmt power.ti.com Medical www.ti.com/medical Microcontrollers microcontroller.ti.com www.ti.com/security Security **RFID** www.ti-rfid.com Space, Avionics & www.ti.com/space-avionics-defense Defense RF/IF and ZigBee® Solutions www.ti.com/lprf Video and Imaging www.ti.com/video www.ti.com/wireless-apps Wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2010, Texas Instruments Incorporated

